



## **Ferrites and accessories**

### **E 6.3 Core and accessories**

**Series/Type:**            **B66300**  
**Date:**                     June 2013

- To IEC 61246
- For miniature transformers, e.g. DC/DC converters for surface mounting
- Available with SMD coil former
- Delivery mode: single units

**Magnetic characteristics** (per set)

$$\Sigma l/A = 3.7 \text{ mm}^{-1}$$

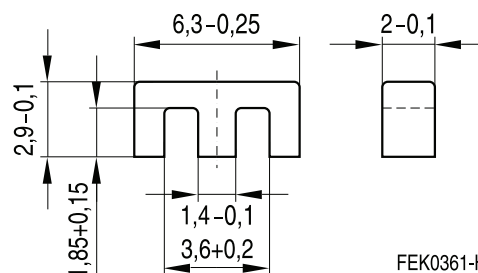
$$l_e = 12.2 \text{ mm}$$

$$A_e = 3.3 \text{ mm}^2$$

$$A_{\min} = 2.6 \text{ mm}^2$$

$$V_e = 40.3 \text{ mm}^3$$

**Approx. weight** 0.24 g/set


**Ungapped**

Material	$A_L$ value nH	$\mu_e$	Ordering code
N87	380 +30/-20%	1120	B66300G0000X187
N30	700 +40/-30%	2059	B66300G0000X130
T38	1700 +40/-30%	4990	B66300G0000X138

**SMD**
**SMD coil former with gullwing terminals**

Material: GFR liquid crystal polymer (UL 94 V-0, insulation class to IEC 60085: F  $\geq$  max. operating temperature 155 °C), color code black  
 B66301B: Vectra E 130i [E106764 (M)], POLYPLASTICS CO LTD  
 Vectra E 130i [E83005 (M)], TICONA  
 B66301C: Vectra C 130 [E106764 (M)], POLYPLASTICS CO LTD

Solderability: to IEC 60068-2-58, test Td, method 6 (Group 3): 245 °C, 3 s

Resistance to soldering heat: to IEC 60068-2-58, test Td, method 6 (Group 3): 255 °C, 10 s  
 permissible soldering temperature for wire-wrap connection on coil former: 400 °C, 1 s

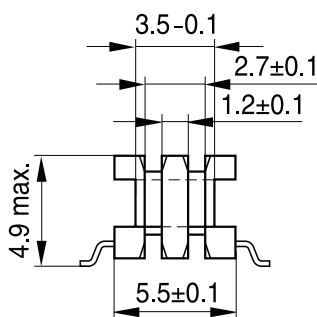
Winding: see Data Book 2013, chapter "Processing notes, 2.1"

**Plastic cover cap**

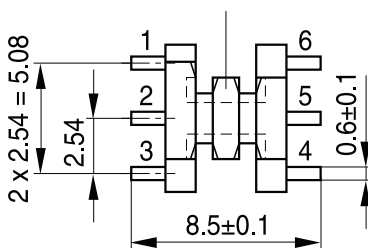
Used to protect the transformer against external influences, for stamping and for improved processing on assembly machines

Material: see coil former, color code white

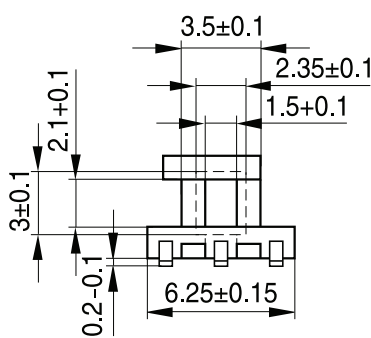
Coil former					Ordering code
Sections	A <sub>N</sub> mm <sup>2</sup>	l <sub>N</sub> mm	A <sub>R</sub> value μΩ	Terminals	
1	1.62	12.8	272	4	B66301B1004T001
				6	B66301B1006T001
2	0.9	12.8	490	6	B66301B1006T002
Plastic cover cap					B66301C2000X000

**Coil former**


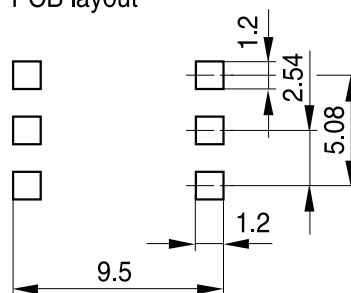
Omitted in 1-section version



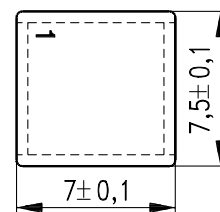
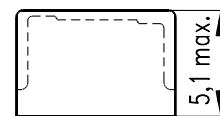
Terminals 2 and 5 are omitted in 4-terminal version



Recommended PCB layout



FEK0447-N-E

**Plastic cover cap**


FEK0287-5

### **Mechanical stress and mounting**

Ferrite cores have to meet mechanical requirements during assembling and for a growing number of applications. Since ferrites are ceramic materials one has to be aware of the special behavior under mechanical load.

As valid for any ceramic material, ferrite cores are brittle and sensitive to any shock, fast changing or tensile load. Especially high cooling rates under ultrasonic cleaning and high static or cyclic loads can cause cracks or failure of the ferrite cores.

For detailed information see chapter *“Definitions”*, section 8.1.

### **Effects of core combination on $A_L$ value**

Stresses in the core affect not only the mechanical but also the magnetic properties. It is apparent that the initial permeability is dependent on the stress state of the core. The higher the stresses are in the core, the lower is the value for the initial permeability. Thus the embedding medium should have the greatest possible elasticity.

For detailed information see chapter *“Definitions”*, section 8.2.

### **Heating up**

Ferrites can run hot during operation at higher flux densities and higher frequencies.

### **NiZn-materials**

The magnetic properties of NiZn-materials can change irreversible in high magnetic fields.

### **Processing notes**

- The start of the winding process should be soft. Else the flanges may be destroyed.
- To strong winding forces may blast the flanges or squeeze the tube that the cores can no more be mounted.
- To long soldering time at high temperature (>300 °C) may effect coplanarity or pin arrangement.
- Not following the processing notes for soldering of the J-leg terminals may cause solderability problems at the transformer because of pollution with Sn oxyd of the tin bath or burned insulation of the wire. For detailed information see chapter *“Processing notes”*, section 8.2.
- The dimensions of the hole arrangement have fixed values and should be understood as a recommendation for drilling the printed circuit board. For dimensioning the pins, the group of holes can only be seen under certain conditions, as they fit into the given hole arrangement. To avoid problems when mounting the transformer, the manufacturing tolerances for positioning the customers' drilling process must be considered by increasing the hole diameter.

**Ferrites and accessories**
**Symbols and terms**

Symbol	Meaning	Unit
A	Cross section of coil	mm <sup>2</sup>
A <sub>e</sub>	Effective magnetic cross section	mm <sup>2</sup>
A <sub>L</sub>	Inductance factor; $A_L = L/N^2$	nH
A <sub>L1</sub>	Minimum inductance at defined high saturation ( $\cong \mu_a$ )	nH
A <sub>min</sub>	Minimum core cross section	mm <sup>2</sup>
A <sub>N</sub>	Winding cross section	mm <sup>2</sup>
A <sub>R</sub>	Resistance factor; $A_R = R_{Cu}/N^2$	$\mu\Omega = 10^{-6} \Omega$
B	RMS value of magnetic flux density	Vs/m <sup>2</sup> , mT
$\Delta B$	Flux density deviation	Vs/m <sup>2</sup> , mT
$\hat{B}$	Peak value of magnetic flux density	Vs/m <sup>2</sup> , mT
$\Delta \hat{B}$	Peak value of flux density deviation	Vs/m <sup>2</sup> , mT
B <sub>DC</sub>	DC magnetic flux density	Vs/m <sup>2</sup> , mT
B <sub>R</sub>	Remanent flux density	Vs/m <sup>2</sup> , mT
B <sub>S</sub>	Saturation magnetization	Vs/m <sup>2</sup> , mT
C <sub>0</sub>	Winding capacitance	F = As/V
CDF	Core distortion factor	mm <sup>-4.5</sup>
DF	Relative disaccommodation coefficient $DF = d/\mu_i$	
d	Disaccommodation coefficient	
E <sub>a</sub>	Activation energy	J
f	Frequency	s <sup>-1</sup> , Hz
f <sub>cutoff</sub>	Cut-off frequency	s <sup>-1</sup> , Hz
f <sub>max</sub>	Upper frequency limit	s <sup>-1</sup> , Hz
f <sub>min</sub>	Lower frequency limit	s <sup>-1</sup> , Hz
f <sub>r</sub>	Resonance frequency	s <sup>-1</sup> , Hz
f <sub>Cu</sub>	Copper filling factor	
g	Air gap	mm
H	RMS value of magnetic field strength	A/m
$\hat{H}$	Peak value of magnetic field strength	A/m
H <sub>DC</sub>	DC field strength	A/m
H <sub>c</sub>	Coercive field strength	A/m
h	Hysteresis coefficient of material	10 <sup>-6</sup> cm/A
h/ $\mu_i^2$	Relative hysteresis coefficient	10 <sup>-6</sup> cm/A
I	RMS value of current	A
I <sub>DC</sub>	Direct current	A
$\hat{I}$	Peak value of current	A
J	Polarization	Vs/m <sup>2</sup>
k	Boltzmann constant	J/K
k <sub>3</sub>	Third harmonic distortion	
k <sub>3c</sub>	Circuit third harmonic distortion	
L	Inductance	H = Vs/A

**Ferrites and accessories**
**Symbols and terms**

Symbol	Meaning	Unit
$\Delta L/L$	Relative inductance change	H
$L_0$	Inductance of coil without core	H
$L_H$	Main inductance	H
$L_p$	Parallel inductance	H
$L_{rev}$	Reversible inductance	H
$L_s$	Series inductance	H
$l_e$	Effective magnetic path length	mm
$l_N$	Average length of turn	mm
$N$	Number of turns	
$P_{Cu}$	Copper (winding) losses	W
$P_{trans}$	Transferrable power	W
$P_V$	Relative core losses	mW/g
PF	Performance factor	
$Q$	Quality factor ( $Q = \omega L/R_s = 1/\tan \delta_L$ )	
$R$	Resistance	$\Omega$
$R_{Cu}$	Copper (winding) resistance ( $f = 0$ )	$\Omega$
$R_h$	Hysteresis loss resistance of a core	$\Omega$
$\Delta R_h$	$R_h$ change	$\Omega$
$R_i$	Internal resistance	$\Omega$
$R_p$	Parallel loss resistance of a core	$\Omega$
$R_s$	Series loss resistance of a core	$\Omega$
$R_{th}$	Thermal resistance	K/W
$R_V$	Effective loss resistance of a core	$\Omega$
$s$	Total air gap	mm
$T$	Temperature	$^{\circ}\text{C}$
$\Delta T$	Temperature difference	K
$T_C$	Curie temperature	$^{\circ}\text{C}$
$t$	Time	s
$t_v$	Pulse duty factor	
$\tan \delta$	Loss factor	
$\tan \delta_L$	Loss factor of coil	
$\tan \delta_r$	(Residual) loss factor at $H \rightarrow 0$	
$\tan \delta_e$	Relative loss factor	
$\tan \delta_h$	Hysteresis loss factor	
$\tan \delta/\mu_i$	Relative loss factor of material at $H \rightarrow 0$	
$U$	RMS value of voltage	V
$\hat{U}$	Peak value of voltage	V
$V_e$	Effective magnetic volume	$\text{mm}^3$
$Z$	Complex impedance	$\Omega$
$Z_n$	Normalized impedance $ Z _n =  Z /N^2 \times \varepsilon (l_e/A_e)$	$\Omega/\text{mm}$

## Ferrites and accessories

### Symbols and terms

Symbol	Meaning	Unit
$\alpha$	Temperature coefficient (TK)	1/K
$\alpha_F$	Relative temperature coefficient of material	1/K
$\alpha_e$	Temperature coefficient of effective permeability	1/K
$\varepsilon_r$	Relative permittivity	
$\Phi$	Magnetic flux	Vs
$\eta$	Efficiency of a transformer	
$\eta_B$	Hysteresis material constant	mT <sup>-1</sup>
$\eta_i$	Hysteresis core constant	A <sup>-1</sup> H <sup>-1/2</sup>
$\lambda_s$	Magnetostriction at saturation magnetization	
$\mu$	Relative complex permeability	
$\mu_0$	Magnetic field constant	Vs/Am
$\mu_a$	Relative amplitude permeability	
$\mu_{app}$	Relative apparent permeability	
$\mu_e$	Relative effective permeability	
$\mu_i$	Relative initial permeability	
$\mu_p'$	Relative real (inductive) component of $\bar{\mu}$ (for parallel components)	
$\mu_p''$	Relative imaginary (loss) component of $\bar{\mu}$ (for parallel components)	
$\mu_r$	Relative permeability	
$\mu_{rev}$	Relative reversible permeability	
$\mu_s'$	Relative real (inductive) component of $\bar{\mu}$ (for series components)	
$\mu_s''$	Relative imaginary (loss) component of $\bar{\mu}$ (for series components)	
$\mu_{tot}$	Relative total permeability derived from the static magnetization curve	
$\rho$	Resistivity	$\Omega\text{m}^{-1}$
$\Sigma l/A$	Magnetic form factor	mm <sup>-1</sup>
$\tau_{Cu}$	DC time constant $\tau_{Cu} = L/R_{Cu} = A_L/A_R$	s
$\omega$	Angular frequency; $\omega = 2 \pi f$	s <sup>-1</sup>

All dimensions are given in mm.

**SMD** Surface-mount device

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